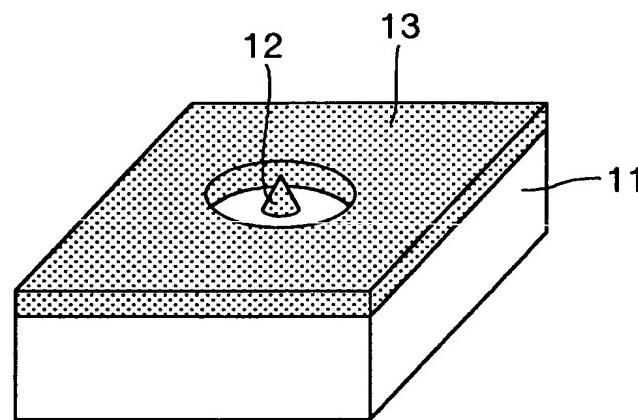
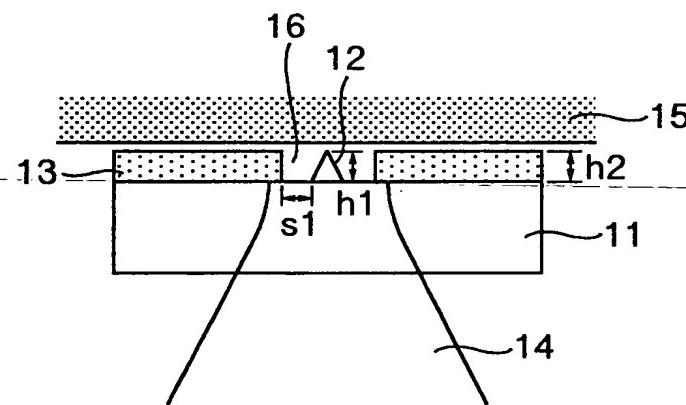


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**FIG.1A****FIG.1B**

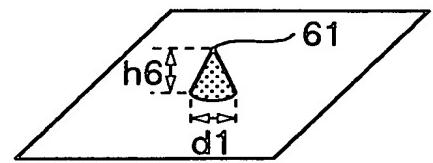


FIG.2A

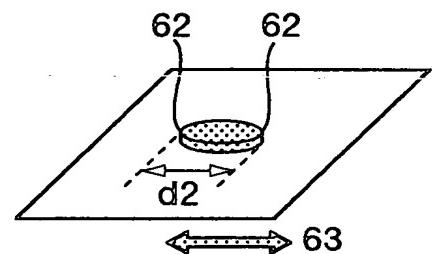


FIG.2B

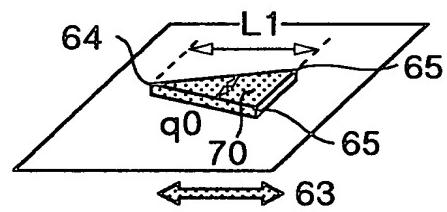


FIG.2C

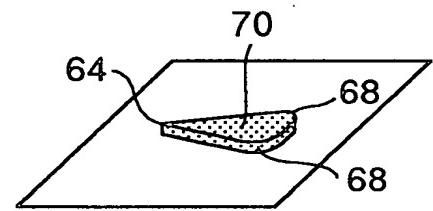


FIG.2D

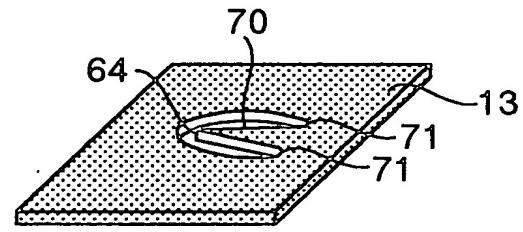


FIG.2E

FIG.3A

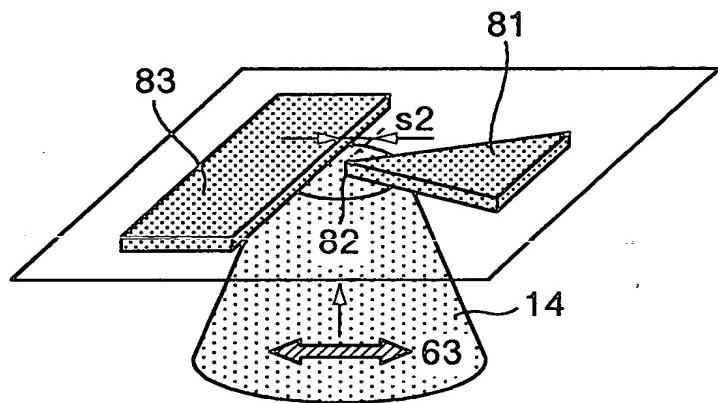


FIG.3B

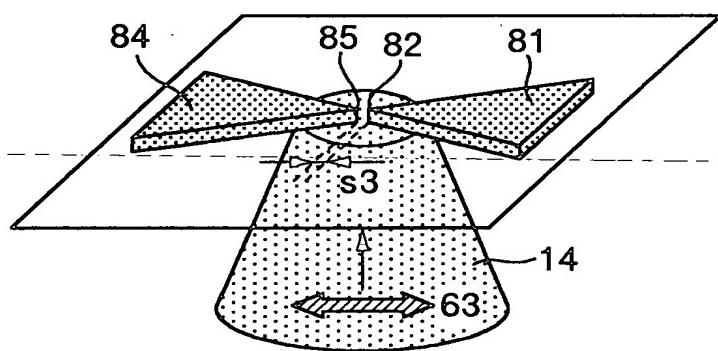


FIG.4A

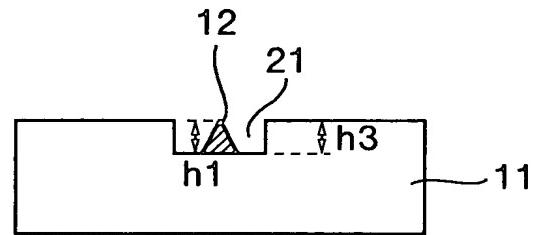


FIG.4B

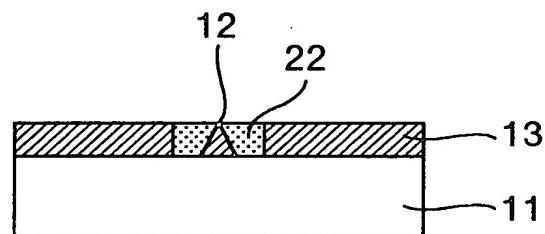


FIG.4C

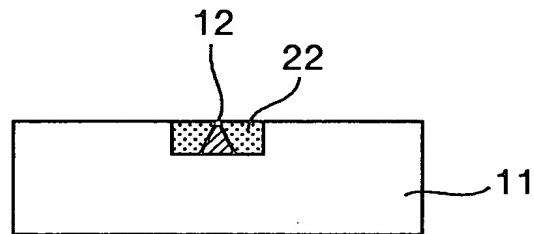


FIG.4D

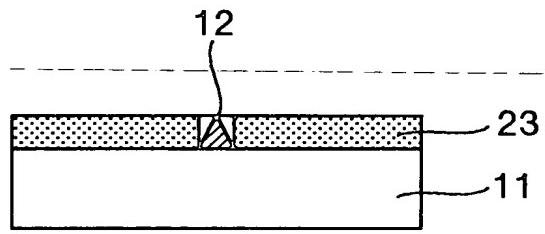


FIG.5A

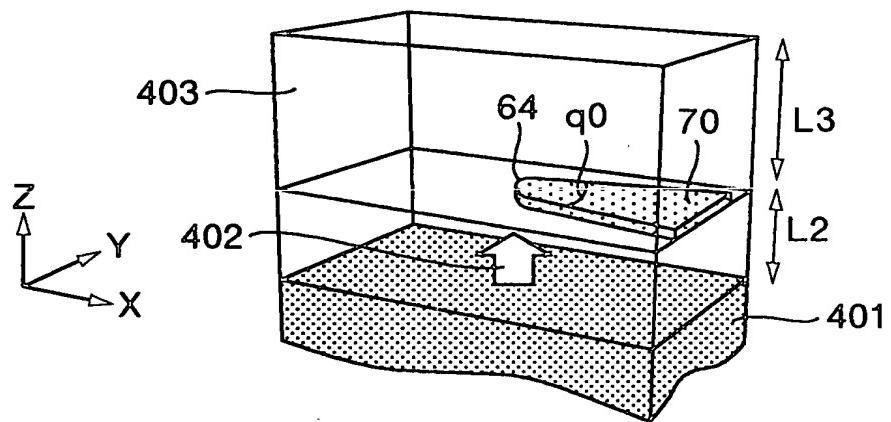
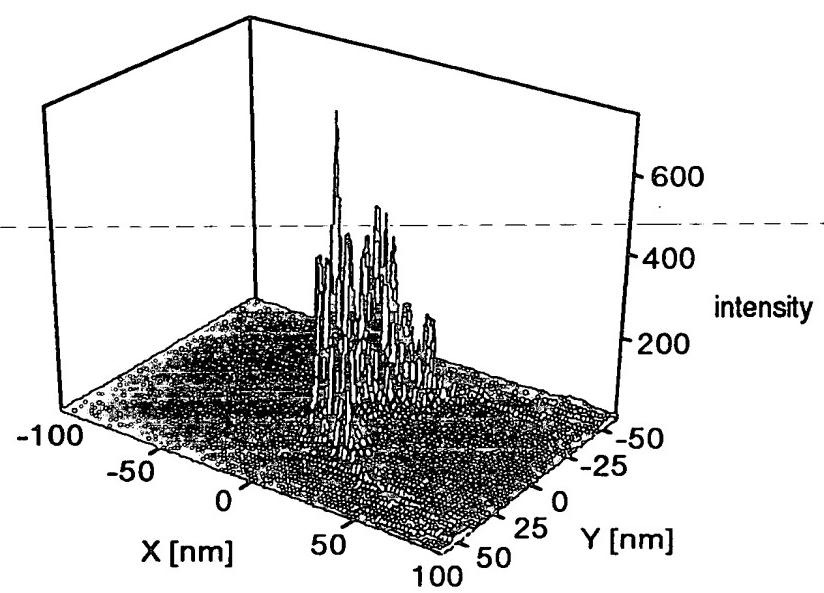


FIG.5B



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FIG.6A

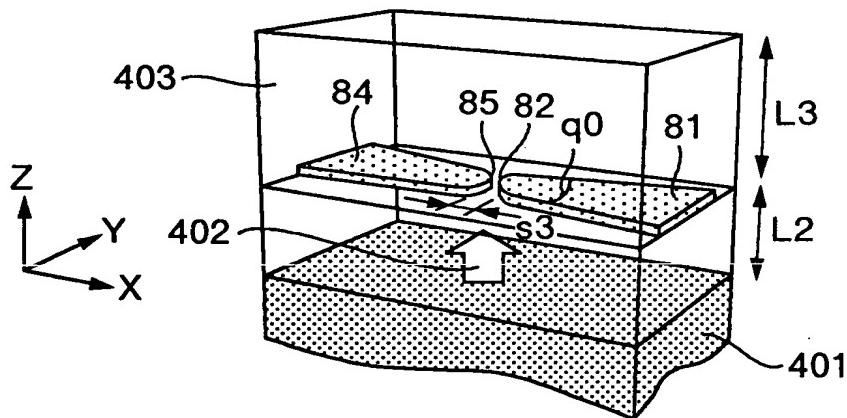
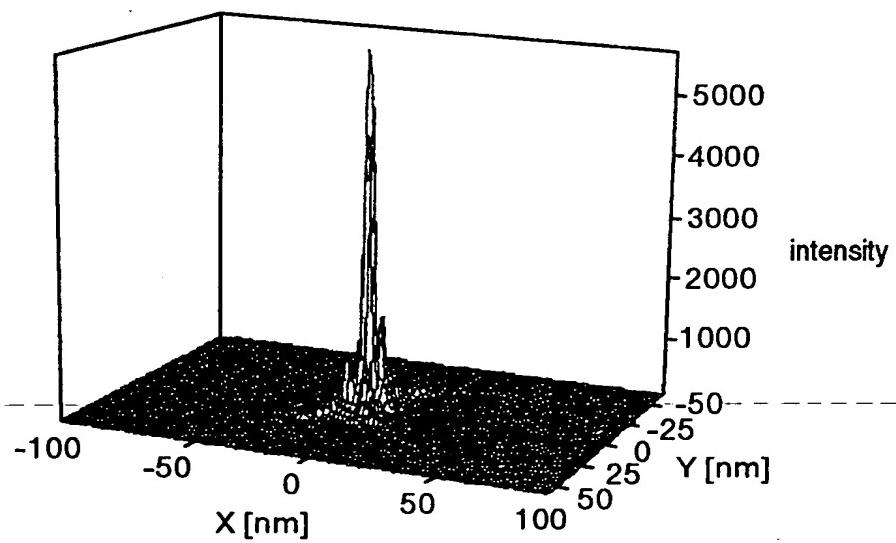


FIG.6B



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FIG.7A

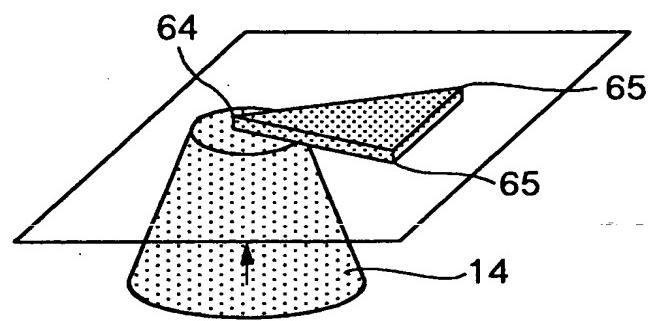
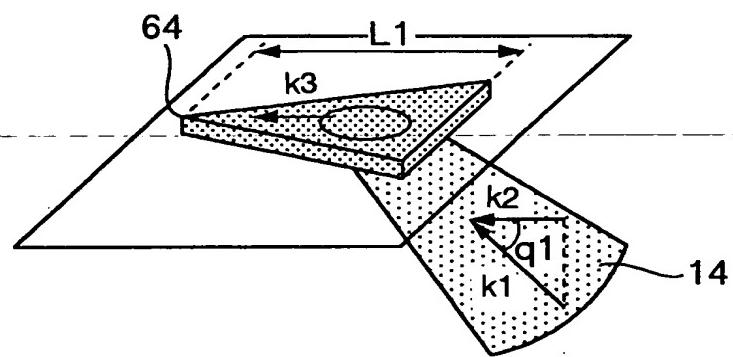
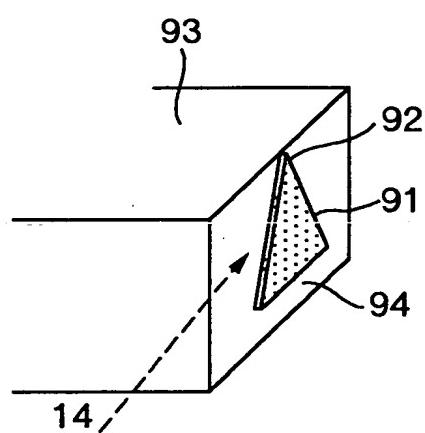


FIG.7B

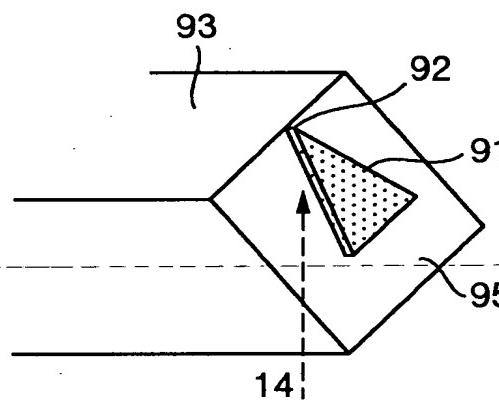


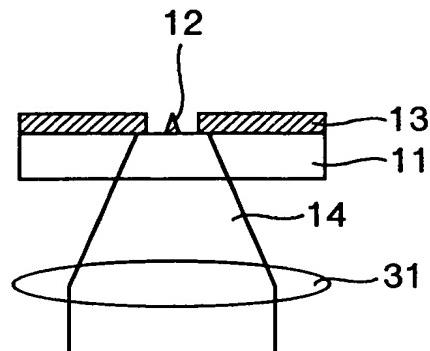
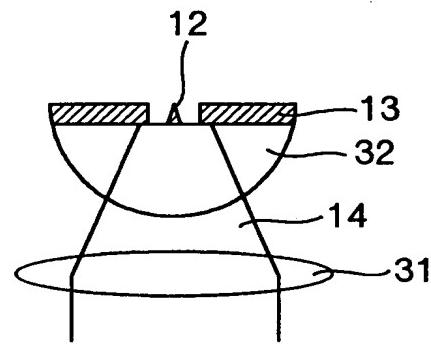
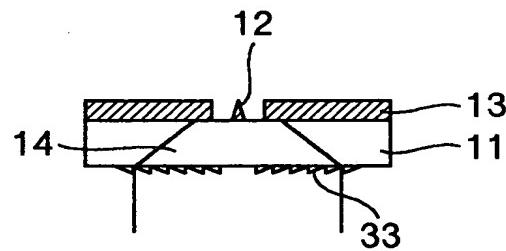
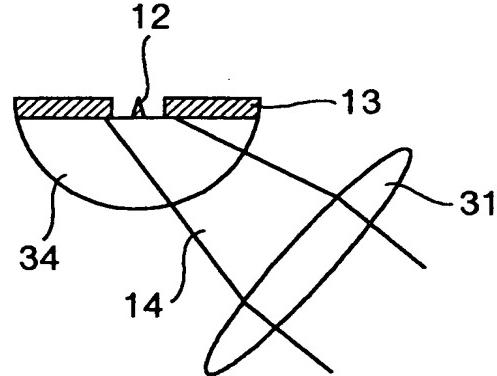
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**FIG.8A**



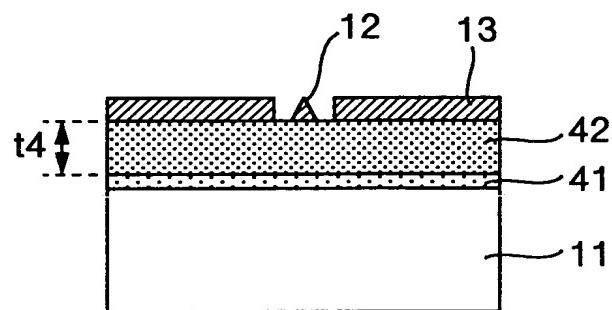
**FIG.8B**



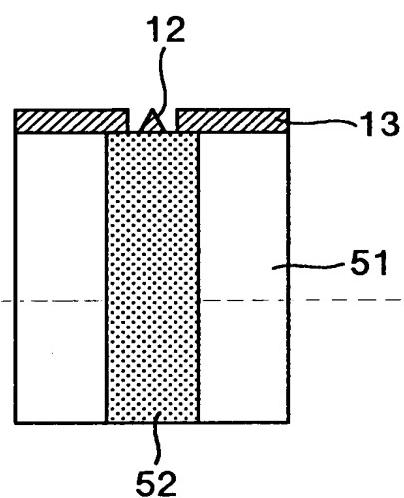
**FIG.9A****FIG.9B****FIG.9C****FIG.9D**

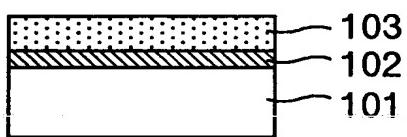
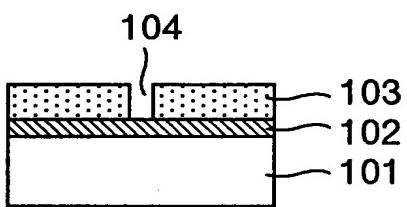
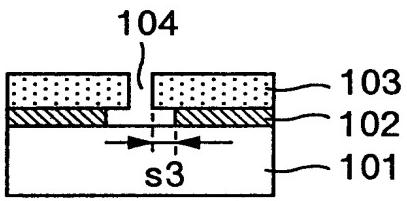
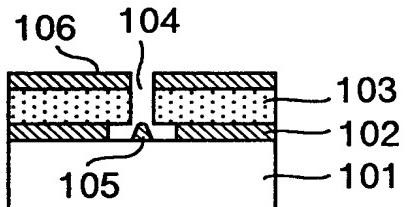
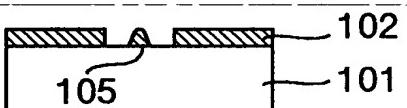
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**FIG.10**

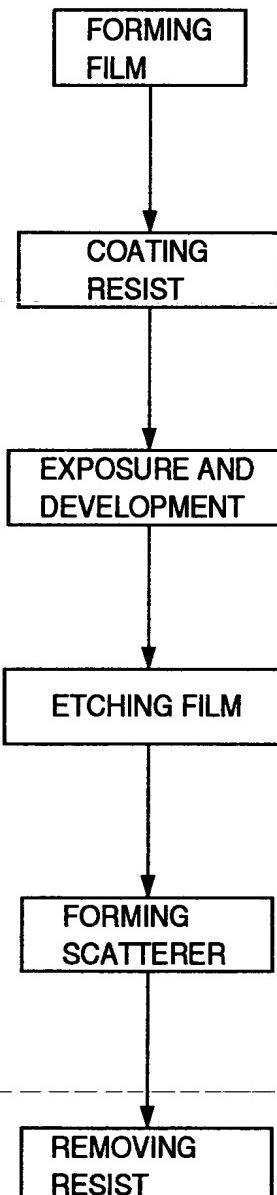


**FIG.11**



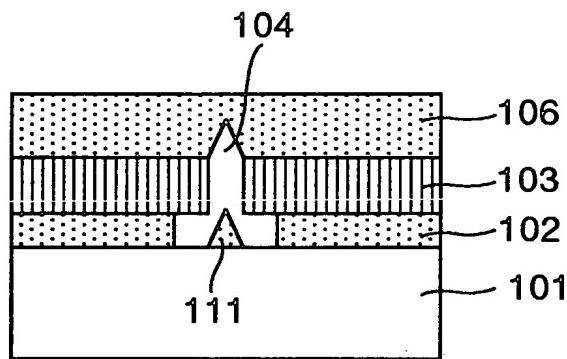
**FIG.12A****FIG.12B****FIG.12C****FIG.12D****FIG.12E****FIG.12F**

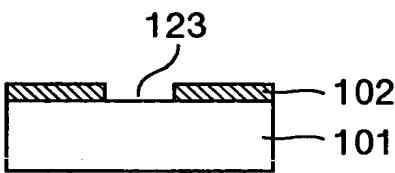
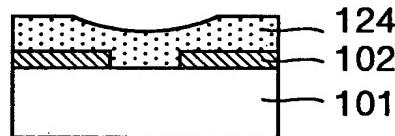
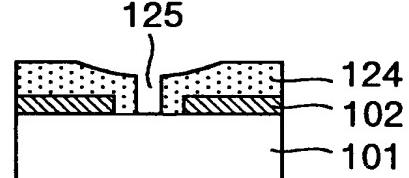
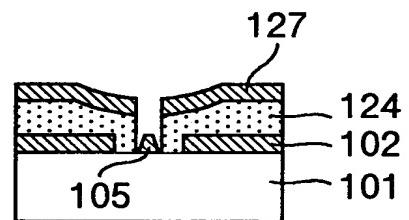
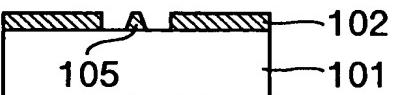
09665594-0962000



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FIG.13



**FIG.14A****FIG.14B****FIG.14C****FIG.14D****FIG.14E****FIG.14F**

FORMING  
FILM

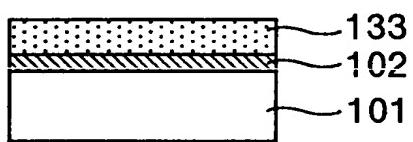
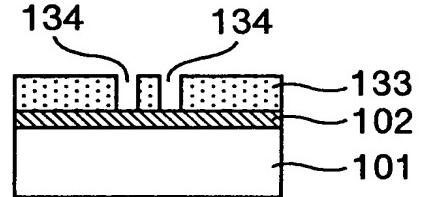
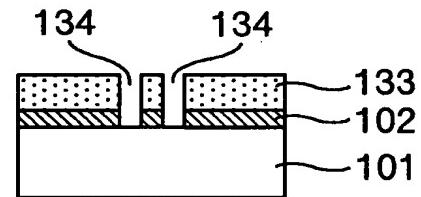
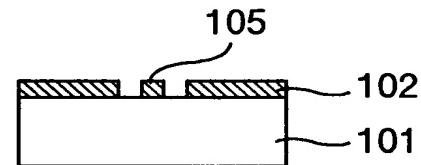
FORMING  
DIP

COATING  
RESIST

EXPOSURE AND  
DEVELOPMENT

FORMING  
SCATTERER

REMOVING  
RESIST

**FIG.15A****FIG.15B****FIG.15C****FIG.15D****FIG.15E**

COATING  
METAL

COATING  
RESIST

EXPOSURE AND  
DEVELOPMENT

ETCHING  
METALLIC FILM

REMOVING  
RESIST

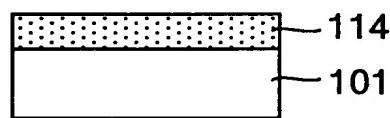
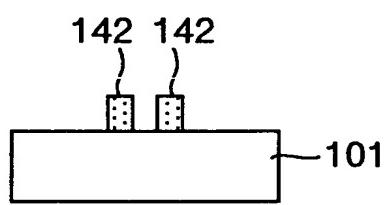
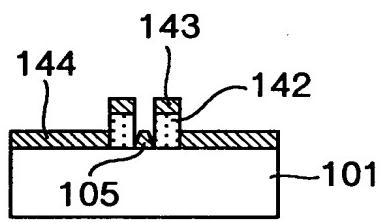
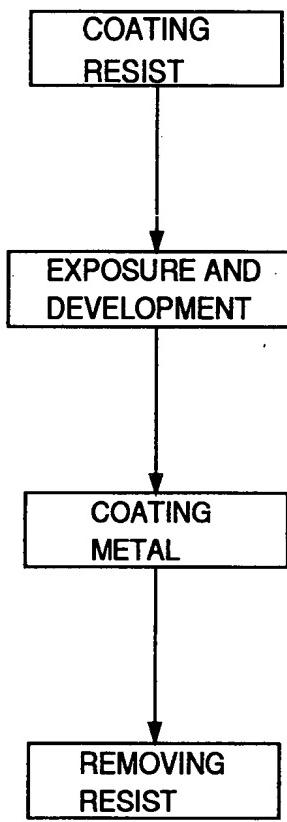
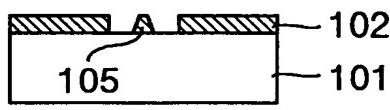
**FIG.16A****FIG.16B****FIG.16C****FIG.16D**

FIG.17A

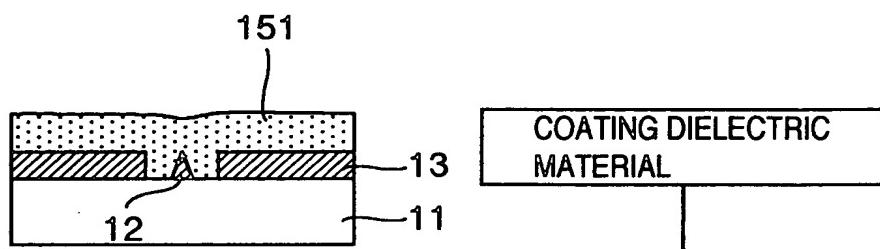


FIG.17B

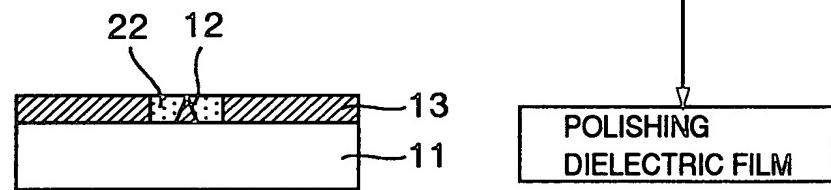
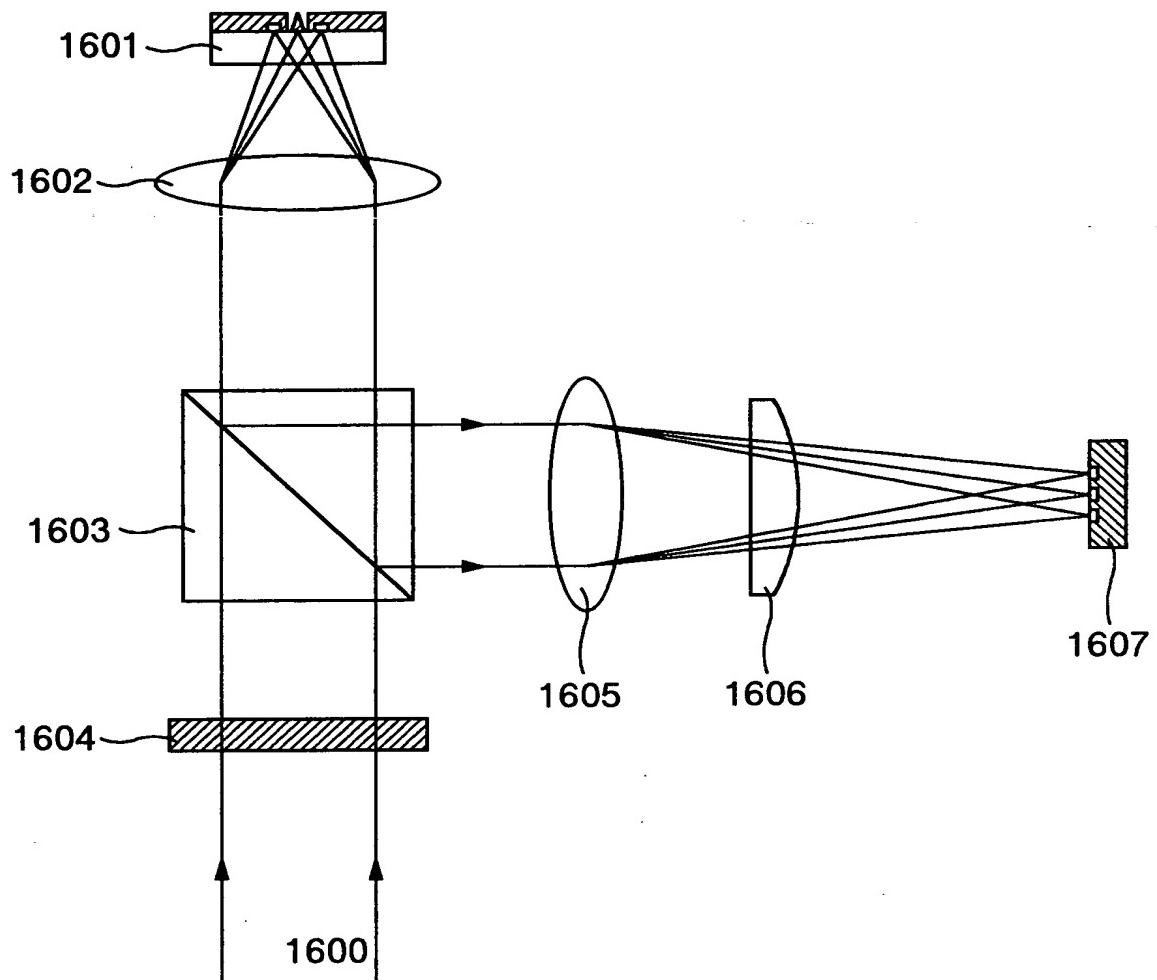
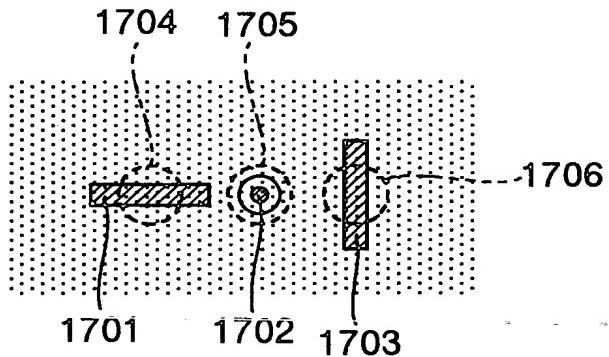
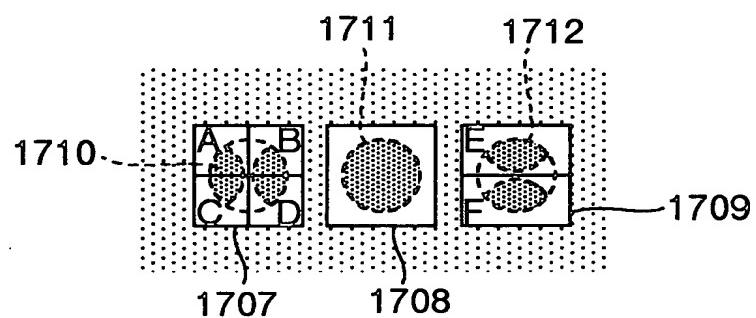
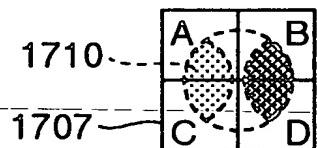
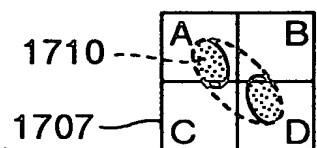
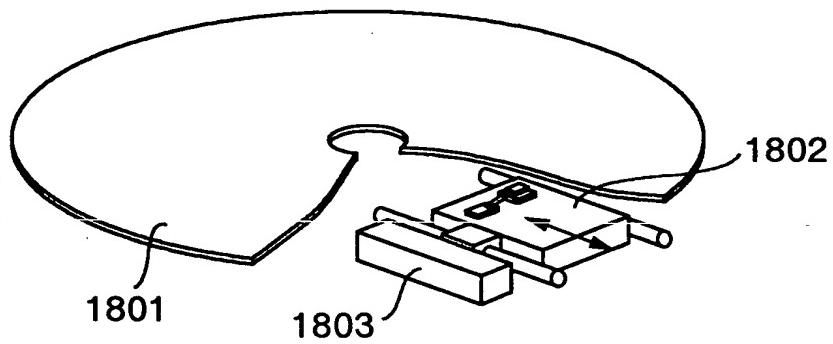
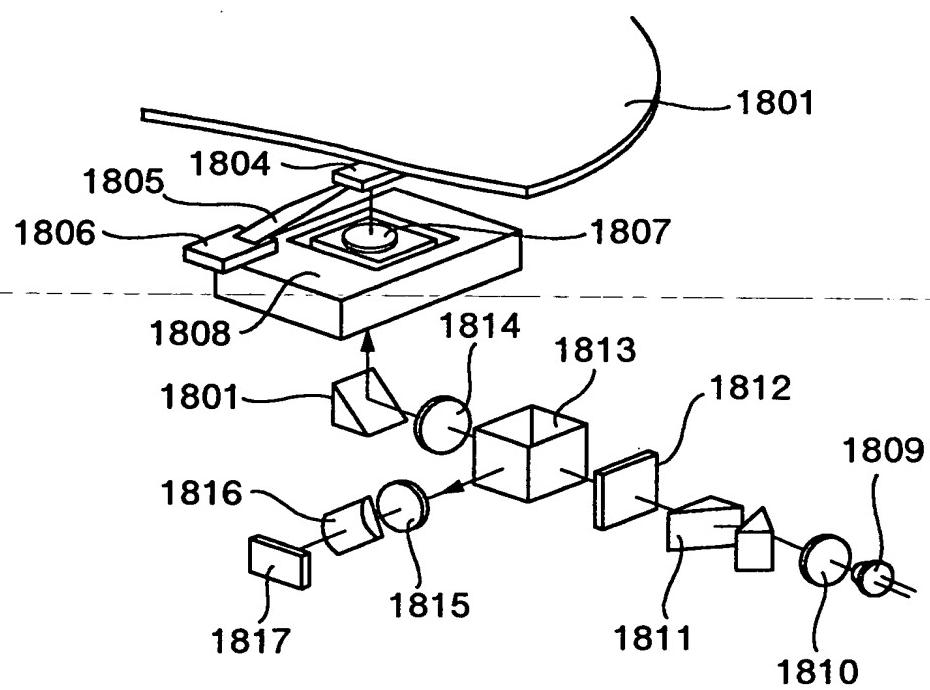


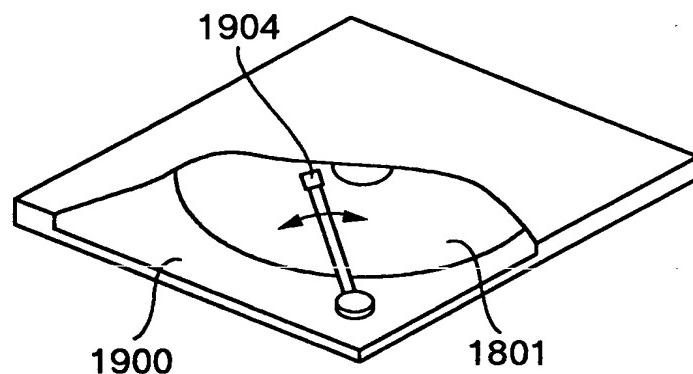
FIG.18



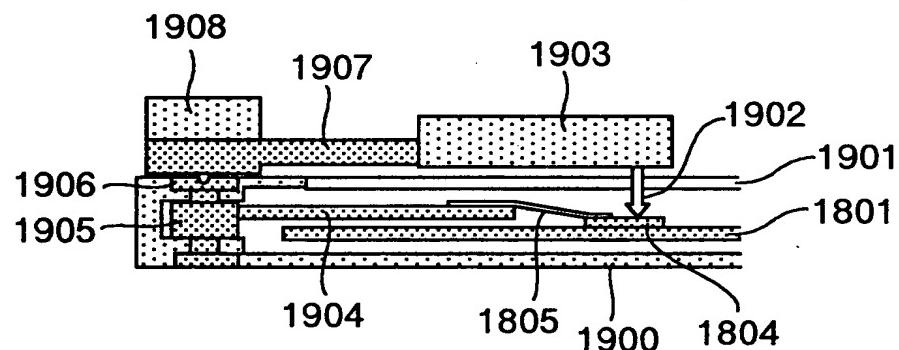
**FIG.19A****FIG.19B****FIG.19C****FIG.19D**

**FIG.20A****FIG.20B**

**FIG.21A**



**FIG.21B**



**FIG.21C**

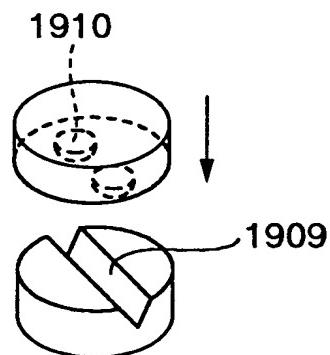


FIG.22A

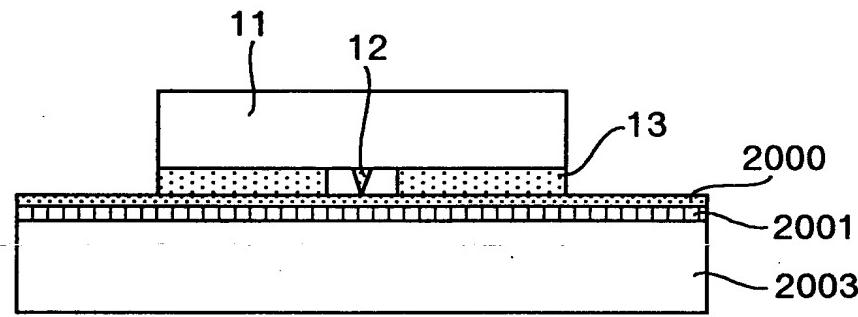


FIG.22B

